

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants : Isao WASEDA et al.

Group Art Unit : Not Yet Assigned

Appl. No. : 10/565,298

(U.S. National Stage of PCT/JP2004/010721)

I.A. Filed : July 28, 2004

Examiner : Not Yet Assigned

For : HEAT TRANSFER TUBE PANEL MODULE AND METHOD OF
CONSTRUCTING EXHAUST HEAT RECOVERY BOILER USING
THE MODULE

INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents
U.S. Patent and Trademark Office
Customer Service Window, Mail Stop AMENDMENT
Randolph Building
401 Dulany Street
Alexandria, VA 22314

Sir :

In accordance with the duty of disclosure under 37 C.F.R. § 1.56 and §§1.97-1.98, Applicants hereby bring the following information to the attention of the Examiner in charge of the above-identified application, which includes information cited and discussed in the specification, the International Search Report, and the International Preliminary Examination Report issued in connection with International Patent Application No. PCT/JP2004/010721, of which the present application is the U.S. National Stage Application. A copy of the International Search Report was enclosed with the papers when entering the U.S. National Stage on January 20, 2006, and a copy of the International Preliminary Examination Report is enclosed herewith. The Examiner is invited to

review these materials to inspect the relevance indicated during international examination with respect to the documents cited therein. The following is a list of the documents cited in the above-noted documents:

U.S. Patent No. 4,685,426 (U.S. Patent Application No. 859,550), together with patent family member Japanese Laid-open Patent Publication No. SHO 62-266301. Applicants note that both of these documents are cited on page 5 of the specification of the present application;

U.S. Patent No. 5,339,891;

Japanese Laid-open Patent Publication No. 2001-41409, together with an English language abstract of the same; and

Japanese Laid-open Patent Publication No. 2002-168403, together with an English language abstract of the same.

Further, Applicants call to the Examiner's attention the following document:

U.S. Patent Application No. 10/563,282 to WASEDA et al., which was filed on January 4, 2006.

Further to 37 C.F.R. §1.98 (a)(2)(ii), copies of the U.S. patent are not enclosed herewith. However, if copies are needed, the Examiner is respectfully requested to contact the undersigned.

Further to the U.S. Patent and Trademark Office's decision to waive the requirement under 37 C.F.R. §1.98 (a)(2)(iii) if the U.S. patent application was filed after June 30, 2003, a copy of the U.S. patent application is not enclosed

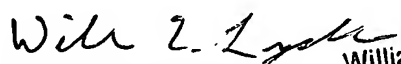
herewith. However, if a copy is needed, the Examiner is respectfully requested to contact the undersigned.

Applicants respectfully request that the Examiner consider the above material and cite the same. Copies of the above-noted foreign documents are attached hereto and all of the above-noted documents are listed on the attached PTO-1449 Form. The Examiner is requested to initial the appropriate spaces on the attached Form and to return a copy of the completed Form to Applicants with the next official communication in the present application.

Applicants note that an Office Action on the merits has not issued in the present application, and thus no fee is believed necessary to ensure consideration of the submitted material.

Should the Examiner have any questions, the Examiner is invited to contact the undersigned at the below-listed telephone number.

Respectfully Submitted,
Isao WASEDA et al.


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FORM PTO-1449

U.S. Department of Commerce
Patent and Trademark OfficeAtty. Docket No.
P29175Application No.
10/565,298INFORMATION DISCLOSURE STATEMENT
BY APPLICANT
(Use several sheets if necessary)Applicant
Isao WASEDA et al.Filing Date
July 28, 2004Group
Unknown

U.S. PATENT DOCUMENTS

EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
		4 6 8 5 4 2 6	08/11/87	KIDALOSKI et al.			
		5 3 3 9 8 9 1	0/23/94	KIDALOSKI et al.			

FOREIGN PATENT DOCUMENTS

		DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION YES NO
	2001	- 0 4 1 4 0 9	02/13/01	JAPAN			
	2002	- 1 6 8 4 0 3	06/14/02	JAPAN			
	62	- 2 6 6 3 0 1	11/19/87	JAPAN			

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)

	1	U.S. Patent Application No. 10/563,282 to WASEDA et al., which was filed on January 4, 2006.
	2	English Language Abstract of JP 2001-041409.
	3	English Language Abstract of JP 2002-266301.

EXAMINER

DATE CONSIDERED

*EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.